

SPECIFICATION SHEET

SPECIFICATION SHEET NO.	R0412- CRCP06FB3R6S01			
DATE	Apr. 12, 2024			
REVISION	A1 Updated With Most Recent Data			
DESCRIPTION AND MAIN PARAMETRICS	High power Chip Resistors, 1206 (3216 Metric), CP06 Series, Dimension L3.10*W1.60*H0.55mm, 2 Terminations, Tolerance: \pm 1.0%, Resistance 3.6 ohm, Dissipation Max. 1/2W @ 70°C, Temperature Coefficient Rate (TCR) Max. \pm 200ppm/° C Operating Temp. Range -55° C ~+155° C Package in Tape/Reel, 5,000pcs/Reel RoHS/RoHS III compliant and HF			
CUSTOMER				
CUSTOMER PART NO.				
CROSS REF. PART NO.				
ORIGINAL MFG/PART NO.	Aillen/CP06FB3R6			
PART CODE	CRCP06FB3R6S	501		

VENDOR APPROVE

Issued/Checked/Approved

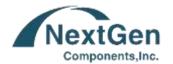






DATE: Apr. 12, 2024

CUSTOMER APPROVE	
DATE:	



HIGH POWER CHIP RESISTORS CP06 SERIES

DESCRIPTION

The resistors are constructed in a high grade ceramic body (aluminum oxide). Internal metal electrodes are added at each end and connected by a resistive paste that is applied to the top surface of the substrate. The composition of the paste is adjusted to give the approximate resistance required and the value is trimmed to within tolerance by laser cutting of this resistive layer. The resistive layer is covered with a protective coat. Finally, the two external end terminations are added. For ease of soldering the outer layer of these end terminations is a Tin (lead free) alloy.

MAIN FEATURE

- High power rating and compact size
- · High reliability and stability
- · Reduced size of final equipment
- RoHS compliant and Lead free products
- Flame Retardant

ROHS COMPLIANT HIF

APPLICATION

- Power supply / PDA
- Digital meter / PC
- Automotives / Battery charger
- DC-DC power converter

HOW TO ORDER

· Please indicate pat code OR custom parameters code and send us your RFQ by E-mail



HIGH POWER CHIP RESISTORS CP06 SERIES

PART CODE GUIDE



CODE	NAME	KEY SPECIFICATION OPTION
CRCP	Product code	High power Chip Resistors
06	Size Code	0402 (1005): L1.00*W0.50mm; 0603 (1608): L1.60*W0.80mm; 0805 (2012): L2.00*W1.25mm; 1206 (3216) : L3.10*W1.60mm;
		1210 (3225:) L3.20*W2.60mm; 2512 (6432): L6.30*W3.10mm;
F	Resistance Range	P: Jumper; B: +/-0.1%; D: +/-0.5%; F: +/-1%; J: +/-5%
	Tolerance Code	
В	Package Code	A: 4Kpcs/7"Reel; B:5kpcs/7"Reel; C:10kpcs/7"Reel; M:15kpcs/7"Reel; D:10kpcs/10"Reel; E:20kpcs/10"Reel
3R6	Resistance value	0R: 0ohm; R75: 0.75ohm; 3R6: 3.6ohm; 20R: 20ohm; 51R: 51ohm; 240R: 240ohm; 390R: 390ohm; 1K:1Kohm; 10K: 10Kohm; 10K5: 10.5Kohm;
		13K7: 13.7Kohm; 39K: 39Kohm; 100K: 100Kohm; 118K: 118Kohm;
		1M: 1.0Mohm; 1M2: 1.2Mohm
S01	Internal control	Custom letter A~Z, a-z or digits (0-9)
	code,	



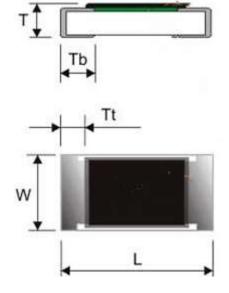
HIGH POWER CHIP RESISTORS CP06 SERIES

DIMENSION (Unit: mm)

Image for reference



CP06 series

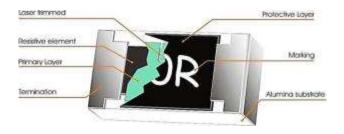


General Marking:

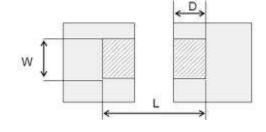
3-digits or 4-digits marking
*Each resistor is marked with
a three or four digits code on
the protective coating to
designate the nominal
resistance value

Item	Dimension
L	3.10±0.15
W	1.60±0.15
Т	0.55±0.10
T b	0.50±0.25
Τt	0.50±0.25

Resistors Construction For Reference



Recommended Solder Pad



Item	Dimension	
W	2.0~2.4	
L	4.4~5.0	
D	1.2~1.8	3

4/12/2024



HIGH POWER CHIP RESISTORS CP06

GENERAL ELECTRONICAL CHARACTERISTICS

	Item		Symbol	Characteristic	Condition
Pro	Product Name		CRCP	High power Chip Resistors	
	Size		06	CP06 Series,	
				L3.10*W1.60*H0.55mm	
Resis	stance Range	Ω		3.6	
Resista	ance Tolerance	%	F	+/-1	
TCR	0.02 ~ 0.043Ω	ppm/°C		≤±1000	
	0.047 ~ 0.0976Ω			≤±200	
	0.1 ~ 0.43Ω			≤±100	
	0.47 ~ 0.976Ω			≤±100	
	1~ 10Ω			≤±200	
	≥10Ω			≤±100	
Max	. Dissipation	W		1/2	@ Tamb=70°C
Operati	ng Temperature	°C		-55 ~+155	
Max. Op	peration Voltage	V		200	@DC or RMS
Max. O	Max. Overload Voltage			400	@DC or RMS

Note

- 1) This is the maximum voltage that may be continuously supplied to the resistor element, see "IEC publication 60115-8"
- 2) Max. Operation Voltage: So called RCWV (Rated Continuous Working Voltage) is determined by

RCWV = $\sqrt{Rated\ Power \times Resistance\ Value}$ or Max. RCWV listed above, whichever is lower.

3) Test condition for jumper (0 Ω)

Item	Unit	Symbol	Characteristic	Condition
Power Rating At 70°C	W		1/2	
Max. Resistance	mΩ		20	
Rated Current	А		5.0	
Peak Current	А		12.5	
Operating Temperature	°C		-55 ~+155	



HIGH POWER CHIP RESISTORS CP06

PRODUCT CHARACTERIZATION

Standard values of nominal resistance are taken from the E24 & E96 series for resistors with a tolerance Of +/-0.1%, +/-0.5%, +/-1% & +/-5%, The values of the E24/E96 series are in accordance with "IEC publication 60063"

DERATING

The power that the resistor can dissipate depends on the operating temperature; see Fig.1

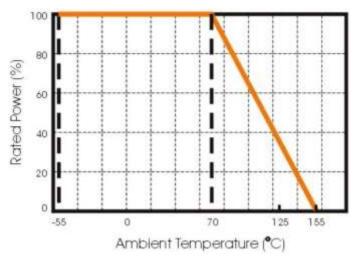


Fig 1 Maximum dissipation in percentage of rated power as a function of the ambient temperature

MOUNTING

Due to their rectangular shapes and small tolerances, Surface Mountable Resistors are suitable for handling by automatic placement systems. Chip placement can be on ceramic substrates and printed-circuit boards (PCBs). Electrical connection to the circuit is by individual soldering condition. The end terminations guarantee a reliable contact.



HIGH POWER CHIP RESISTORS CP06

REFLOW SOLDERING CONDITION

The robust construction of chip resistors allows them to be completely immersed in a solder bath of 260 °C for 10 seconds. Therefore, it is possible to mount Surface Mount Resistors on one side of a PCB and other discrete components on the reverse (mixed PCBs). Surface Mount Resistors are tested for solderability at 235 °C during 2 seconds. The test condition for no leaching is 260°C for 30 seconds. Typical examples of soldering processes that provide reliable joints without any damage are given in Fig 2.

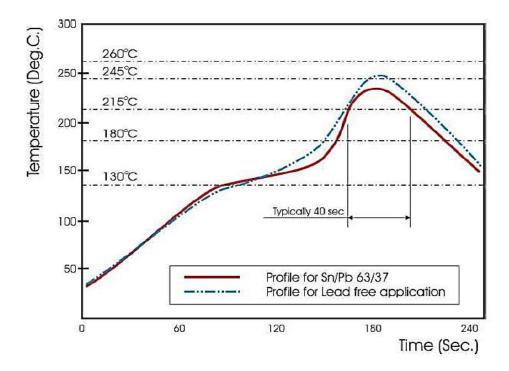


Fig 2. Infrared soldering profile for Chip Resistors

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TEST AND REQUIREMENT (JIS C 5201-1: 1998)

TEST	PROCEDURE / TEST METHOD	REQUIREMENT
Temperature	Natural resistance change per change in degree	Refer to quick reference data
Coefficient of	centigrade. $R_1 - R_2$	for T.C.R specification
Resistance(T.C.R)	centigrade. $\frac{R_2 - R_1}{R_1(t_2 - t_1)} \times 10^6 \text{ (ppm/°C)}$	
Clause 4.8	t1:20°C+5°C-1°C	
	R1 : Resistance at reference temperature	
	R2: Resistance at test temperature	
Short time overload	5.0× Rated power or Max. Overload Voltage for 5 sec.	Δ R/R max. J:≦ ±(2%+0.1Ω)
(S.T.O.L) Clause 4.13	Measure resistance after 30 minutes	B,D, F:≦ ±(1%+0.05Ω)
Resistance to	Un-mounted chips completely immersed for	Δ R/R max. J: \leq ±(1%+0.1 Ω)
soldering heat(R.S.H)	10±1second in a SAC solder bath at 260°C±5ºC	B,D, F:≦ ±(0.5%+0.05Ω)
Clause 4.18		No visible damage
Solderability	Un-mounted chips completely immersed for 2±0.5	Good tinning (>95% covered)
Clause 4.17	second in a SAC solder bath at 235°C±5°C	No visible damage
Clause 4.18	Un-mounted chips completely immersed for	Ditto
Leach Test	60±1second in a solder bath at 260°C±5°C	
Temperature cycling	30 minutes at -55°C±3°C, 2~3 minutes at 20°C+5°C-1°C,	Δ R/R max. J \leq ±(1%+0.1Ω)
Clause 4.19	30 minutes at +155°C±3°C, 2~3 minutes at 20°C+5°C-	B,D,F≦ ±(0.5%+0.05Ω)
	1°C, total 5 continuous cycles	No visible damage
Damp Heat	1000 +48/-0 hours, loaded with RCWV or Vmax in	Δ R/R max. J \leq ±(3%+0.1 Ω)
(Load life in humidity)	humidity chamber controller at 40°C±2°C and 90~95%	B,D,F≦ ±(1%+0.05Ω)
Clause 4.24	relative humidity, 1.5hours on and 0.5 hours off	No visible damage
Load life (endurance)	1000 +48/-0 hours, loaded with RCWV or Vmax in	Δ R/R max. J \leq ±(3%+0.1 Ω)
JISC5201-1: 1998	chamber controller 70±2°C, 1.5 hours on and 0.5 Hours	B,D,F≦ ±(1%+0.05Ω)
Clause 4.25	off	No visible damage
Bending strength	Resistors mounted on a 90mm glass epoxy resin	Δ R/R max. J \leq ±(1%+0.1 Ω)
Clause 4.33	PCB(FR4); bending : 2 mm(2512;2010) 3mm(1206),	B,D,F \leq ±(0.5%+0.05Ω)
	once for 10 seconds	No visible damage



HIGH POWER CHIP RESISTORS CP06 SERIES

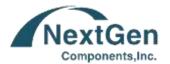
TEST AND REQUIREMENT (JIS C 5201-1: 1998)

TEST	PROCEDURE / TEST METHOD	REQUIREMENT
Adhesion Clause 4.32	Pressurizing force: 5N, Test time: 10±1sec.	No remarkable damage or removal of the terminations
Insulation Resistance Clause 4.6	Apply the maximum overload voltage (DC) for 1minute	R≥10GΩ
Dielectric Withstand Voltage Clause 4.7	Apply the maximum overload voltage (AC) for 1 minute	No breakdown or flashover

STORAGE AND HANDLING CONDITIONS

- 1. Products are recommended to be used up within two years since operation date as ensured shelf life. Check solderability in case shelf life extension is needed.
- 2. To store products with following condition: Temperature : 5 to 40°C Humidity: 20 to 70% relative humidity
- 3. Don't store products in a corrosive environment such as sulfide, chloride gas, or acid. It may cause oxidization of electrode, which easily be resulted in poor soldering b.To store products on the shelf and avoid exposure to moisture. Don't expose products to excessive shock, vibration, direct sunlight and so on.

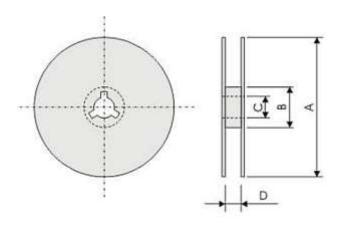
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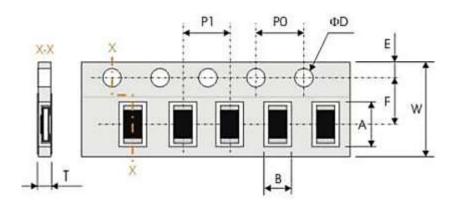
REEL DIMENSION (Unit: mm)

7": 5,000Ppcs/Reel



Code	Dimension 7"	Dimension 10"	Dimension 13"
А	178.0+/-2.0	254.0+/-2.0	330.0+/-2.0
В	60.0 +/-1.0	100 +/-1.0	100+/-1.0
С	13.0+/-0.20	13.0+/-0.20	13.0+/-0.20
D	9.0±0.5	9.0±0.5	9.0±0.5

TAPE DIMENSION (Unit: mm)



Code	Dimension
А	3.60±0.20
В	2.00±0.20
W	8.00±0.30
F	3.50±0.20
E	1.75±0.10
P 1	4.00±0. 10
P0	4.00±0.10
ФD	1.50±0.10
Т	1.0 Max.

TAPING QUANTITY AND TAPE MATERIAL

Таре	Paper Tape						Embossed Tape	Bulk Cassette
		4 mm Pitch	2 mm Pitch			4 mm Pitch		
Reel Size	7"	10"	13"	7"	10"	13"	7"	
CP06	5000	10000	20000	-	-	-	-	5000



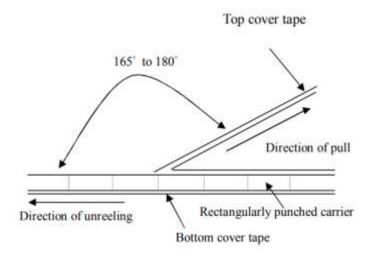
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PERFORMANCE OF TAPING

Strength of Carrier Tape and Top Cover Tape

Carrier Tape: When a tensile force 1.02kgf is applied in the direction of unreeling the tape, the tape shall withstand this force. Top cover Tape: When a tensile force 1.02kgf is applied to the tape, the tape shall withstand this force. Peel Force of Top Cover Tape

Unless otherwise specified, the peel force of top cover tape shall be 10.2 to 71.4 g f when the top cover tape is pulled at a speed of 300mm/min with the angle between the taped during peel and the direction of unreeling maintained at 165 to 180°as illustrated in Fig.



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HIGH POWER CHIP RESISTORS CP06

ROHS COMPLIANCE

 The levels of RoHS restricted materials in this product are below the maximum concentration values (also referred to as the threshold limits) permitted for such substances, or are used in an exempted application, in accordance with EU RoHS Directive (EU) 2015/863 EC (RoHS3). RoHS Test Report for this product can be obtained can be obtained at Download Center.

REACH COMPLIANCE

REACH substances of high concern (SVHCs) information is available for this product. Since the European
Chemical Agency (ECHA) has published notice of their intent to frequently revise the SVHC listing for the
foreseeable future, REACH Test Report for this product can be obtained can be obtained at Download Center.

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 conditions, unless otherwise noted. Product performance may not be indicated by the Electrical
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